

# **Excellent Integrated System Limited**

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Vishay/Siliconix SI7454CDP-T1-GE3

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Datasheet of SI7454CDP-T1-GE3 - MOSFET N-CH 100V 22A PPAK SO-8

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**New Product** 



### Si7454CDP

Vishay Siliconix

## N-Channel 100 V (D-S) MOSFET

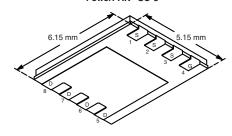
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	$(\Omega)$ $I_D(A)^a$ $Q_g(Ty)$		
100	0.0305 at V <sub>GS</sub> = 10 V	22		
	0.033 at V <sub>GS</sub> = 7.5 V	21	9.5 nC	
	0.043 at V <sub>GS</sub> = 4.5 V	18.5		

### **FEATURES**

- Halogen-free According to IEC 61249-2-21 **Definition**
- TrenchFET® Power MOSFET
- 100 %  $R_g$  Tested 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC



#### PowerPAK® SO-8

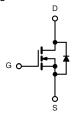


Bottom View

Ordering Information: Si7454CDP-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **APPLICATIONS**

- DC/DC Primary Side Switch
- Telecom/Server 48 V, Full/Half-Bridge dc-to-dc
- Industrial



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b>	T <sub>A</sub> = 25 °C, unles	ss otherwise note	ed		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	100	V		
Gate-Source Voltage		V <sub>GS</sub>	± 20	¬	
	T <sub>C</sub> = 25 °C		22		
Continuous Drain Current (T = 150 °C)	T <sub>C</sub> = 70 °C		17.6		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	8.1 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		6.5 <sup>b, c</sup>	Α	
Pulsed Drain Current		I <sub>DM</sub>	40	A	
Ocation and Common Brain Binds Commont	T <sub>C</sub> = 25 °C	1	22		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	l <sub>S</sub>	3.7 <sup>b, c</sup>		
Single Pulse Avalanche Current		I <sub>AS</sub>	15		
Single Pulse Avalanche Energy  L = 0.1 mH		E <sub>AS</sub>	11.2	mJ	
	T <sub>C</sub> = 25 °C		29.7		
Martin or Brown Blackwart	T <sub>C</sub> = 70 °C	D	19	14/	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	4.1 <sup>b, c</sup>	— w	
	T <sub>A</sub> = 70 °C		2.6 <sup>b, c</sup>		
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150			
Soldering Recommendations (Peak Temperature		260	- °C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 10 s	$R_{thJA}$	24	30	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	$R_{thJC}$	3.3	4.2	O/ VV	

#### Notes:

- a. Based on  $T_C = 25$  °C.
- b. Surface mounted on 1" x 1" FR4 board.
- d. See solder profile (www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 70 °C/W.

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### Si7454CDP

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static			L		L	L	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	—— ID = 250 ЦА		47		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 5.4			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.2		2.8	٧	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V			1	μА	
	I <sub>DSS</sub>	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
	, ,	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A		0.0252	0.0305	<u> </u>	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 7.5 \text{ V}, I_D = 8 \text{ A}$		0.027	0.033	Ω	
	` '	$V_{GS} = 4.5 \text{ V}, I_D = 6 \text{ A}$		0.0345	0.043		
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 10 A		20		S	
Dynamic <sup>b</sup>	_ L		l				
Input Capacitance	C <sub>iss</sub>			580			
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		347		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			24			
'	100	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A		12.8	19.5		
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 10 A		9.8	15		
-		V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A		6.3	9.5	nC	
Gate-Source Charge				1.8			
Gate-Drain Charge	Q <sub>gd</sub>			2.9			
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.8	3.8	7.6	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			8	16		
Rise Time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, R_L = 5 \Omega$		12	24	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		16	32		
Fall Time	t <sub>f</sub>			10	20		
Turn-On Delay Time	t <sub>d(on)</sub>			10	20		
Rise Time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, R_{L} = 5 \Omega$		12	24		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 7.5 \text{ V}, R_g = 1 \Omega$		17	34	1	
Fall Time	t <sub>f</sub>	•		10	20	1	
<b>Drain-Source Body Diode Characteristic</b>	s		l				
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			22		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				40	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 4 A		0.78	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			31	62	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	1		28	56	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		15			
Reverse Recovery Rise Time	t <sub>b</sub>			16		ns	

#### Notes:

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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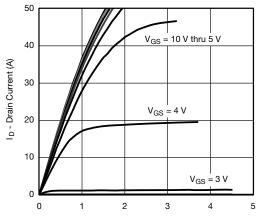
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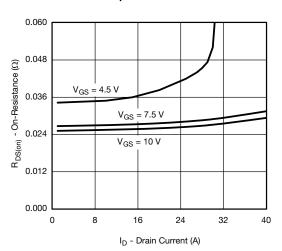
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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

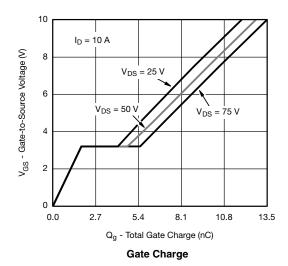


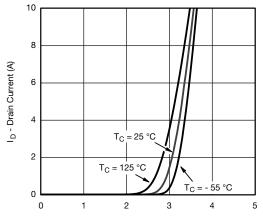
V<sub>DS</sub> - Drain-to-Source Voltage (V)

#### **Output Characteristics**



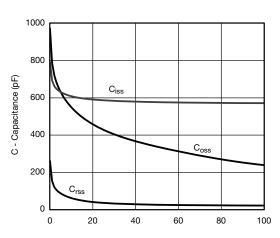
On-Resistance vs. Drain Current and Gate Voltage





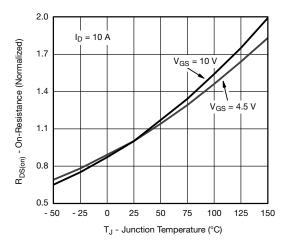
V<sub>GS</sub> - Gate-to-Source Voltage (V)

#### **Transfer Characteristics**



V<sub>DS</sub> - Drain-to-Source Voltage (V)

### Capacitance



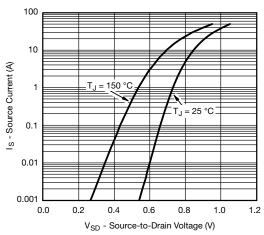
On-Resistance vs. Junction Temperature

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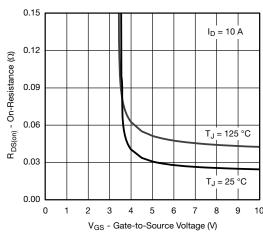
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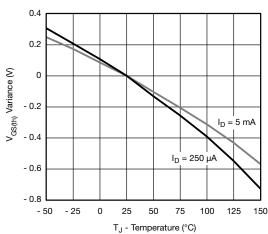
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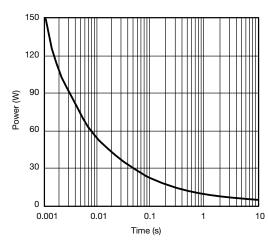
Source-Drain Diode Forward Voltage



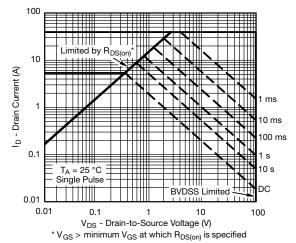
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient



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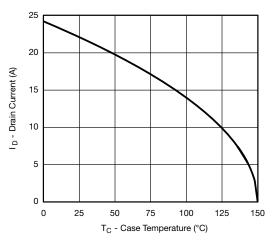
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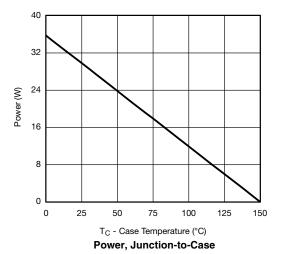
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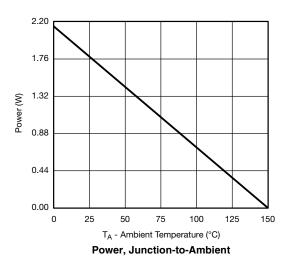
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



#### **Current Derating\***





<sup>\*</sup> The power dissipation PD is based on TJ(max) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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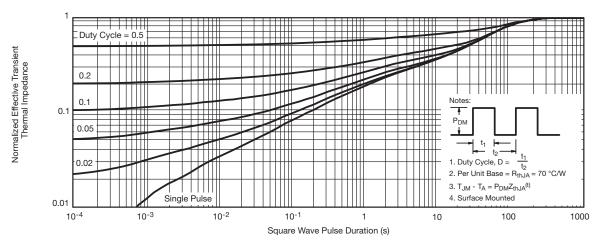
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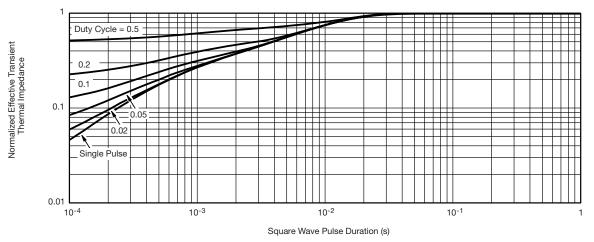
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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65940.



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